

6MBI180VX-120-55

IGBT Modules

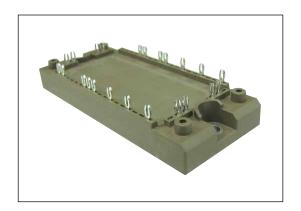
IGBT MODULE (V series) 1200V / 180A / 6 in one package

■ Features

Compact Package P.C.Board Mount Low VcE (sat)

Applications

Inverter for Motor Drive AC and DC Servo Drive Amplifier Uninterruptible Power Supply Industrial machines, such as welding machines



■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings (at T_c=25°C unless otherwise specified)

Items			Symbols	Conditions		Maximum ratings	Units	
	Collector-Emitter voltage		Vces			1200	V	
rter	Gate-Emitter voltage		V _{GES}			±20	V	
	Collector current		Ic	Continuous	Tc=100°C	150		
nvert			Ic pulse	1ms	Tc=80°C	400	۸	
<u>=</u>			-lc			150	Α	
			-I _C pulse	1ms		400		
	Collector power dissipation		Pc	1 device		1075	W	
Junction temperature			T _j			175		
Operating junciton temperature (under switching conditions)			Тјор			150	°C	
Case temperature		Tc	125					
Storage temperature		T _{stg}	-40 ~ +125					
Isc	lation voltage	Between terminal and copper base (*1) Between thermistor and others (*2)	Viso	AC : 1min.		2500	VAC	
Sc	rew torque	Mounting (*3)	-	M5		3.5	N m	

Note *1: All terminals should be connected together during the test.

Note *2: Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

Note *3: Recommendable value : 2.5-3.5 Nm (M5)

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● Electrical characteristics (at T_j= 25°C unless otherwise specified)

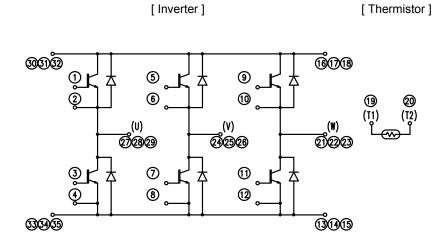
	Complete la	Conditions		Characteristics			I I mida
ems	Symbols			min.	typ.	max.	Units
Zero gate voltage collector current	Ices	V _{GE} = 0V, V _{CE} = 1200V		-	-	1.0	mA
Gate-Emitter leakage current	ate-Emitter leakage current IGES VGE = 0V, VGE = ±20V		-	-	200	nA	
Gate-Emitter threshold voltage	V _{GE (th)}	V _{CE} = 20V, I _C = 200mA		6.0	6.5	7.0	V
Collector-Emitter saturation voltage		V _{GE} = 15V I _C = 200A	Tj=25°C	-	2.70	3.15	V
	V _{CE (sat)} (terminal)		Tj=125°C	-	3.05	-	
	(terrillial)		Tj=150°C	-	3.10	-	
		V _{GE} = 15V I _C = 200A	Tj=25°C	-	1.85	2.30	
	V _{CE (sat)} (chip)		Tj=125°C	-	2.20	-	
	(Criip)		Tj=150°C	-	2.25	-	
Internal gate resistance	R _{G (int)}	-		-	3.8	-	Ω
Input capacitance Turn-on time	Cies	V _{CE} = 10V, V _{GE} = 0V, f = 1MHz		-	16.5	-	nF
Turn-on time	ton	$V_{cc} = 600V$ $I_{c} = 200A$ $V_{GE} = +15 / -15V$ $R_{G} = 1.2\Omega$		-	0.39	1.20	μs
	t			-	0.09	0.60	
	t _{r (i)}			-	0.03	-	
	toff			-	0.53	1.00	
Turn-off time	tr			-	0.06	0.30	
Forward on voltage		I _F = 200A	Tj=25°C	-	2.55	3.00	V
	V _F		Tj=125°C	-	2.70	-	
	(terminal)		Tj=150°C	-	2.65	_	
		I _F = 200A	Tj=25°C	-	1.70	2.15	
	V _F		Tj=125°C	-	1.85	-	
	(chip)		Tj=150°C	-	1.80	-	1
Reverse recovery time	t _{rr}	I _F = 200A		_	-	0.35	μs
		T = 25°C		_	5000	-	Ω
Resistance B value	R	T = 100°C		465	495	520	
B value	В	T = 25 / 50°C		3305	3375	3450	К

● Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Units
items	Symbols	Conditions	min.	typ.	max.	Ullits
Thermal variation on (4 device)	В	Inverter IGBT	-	-	0.14	°C/W
Thermal resistance (1device)	R _{th(j-c)}	Inverter FWD	-	-	0.25	
Contact thermal resistance (1device) (*4)	R _{th(c-f)}	with Thermal Compound	-	0.05	-	

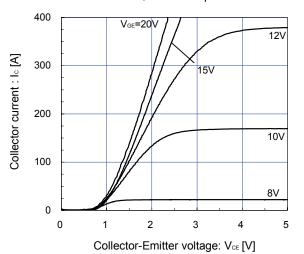
Note *4: This is the value which is defined mounting on the additional cooling fin with thermal compound.

■ Equivalent Circuit Schematic

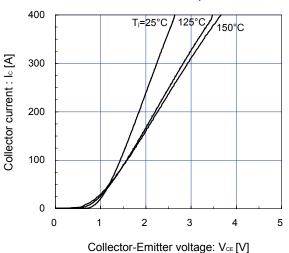


■ Characteristics (Representative)

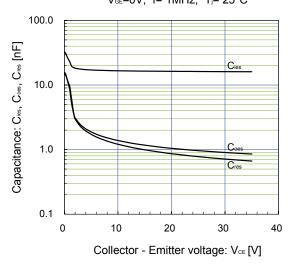
[Inverter]
Collector current vs. Collector-Emitter voltage (typ.)
T_j= 25°C / chip



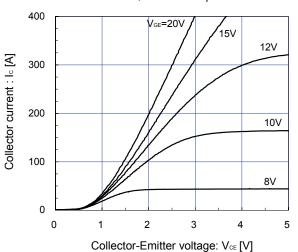
 $[Inverter\] \\ Collector\ current\ vs.\ Collector-Emitter\ voltage\ (typ.) \\ V_{\text{GE}} = 15V\ /\ chip$

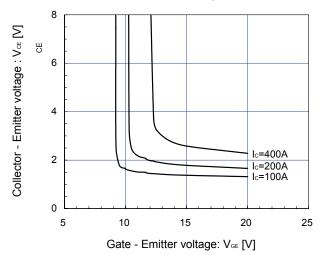


 $\label{eq:continuous} \begin{tabular}{ll} [Inverter] \\ Capacitance vs. Collector-Emitter voltage (typ.) \\ V_{\text{GE}} = 0V, \ f = 1MHz, \ T_j = 25^{\circ}C \end{tabular}$



[Inverter] Collector current vs. Collector-Emitter voltage (typ.) T_i = 150°C / chip

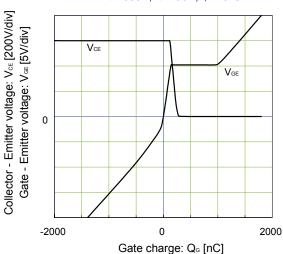


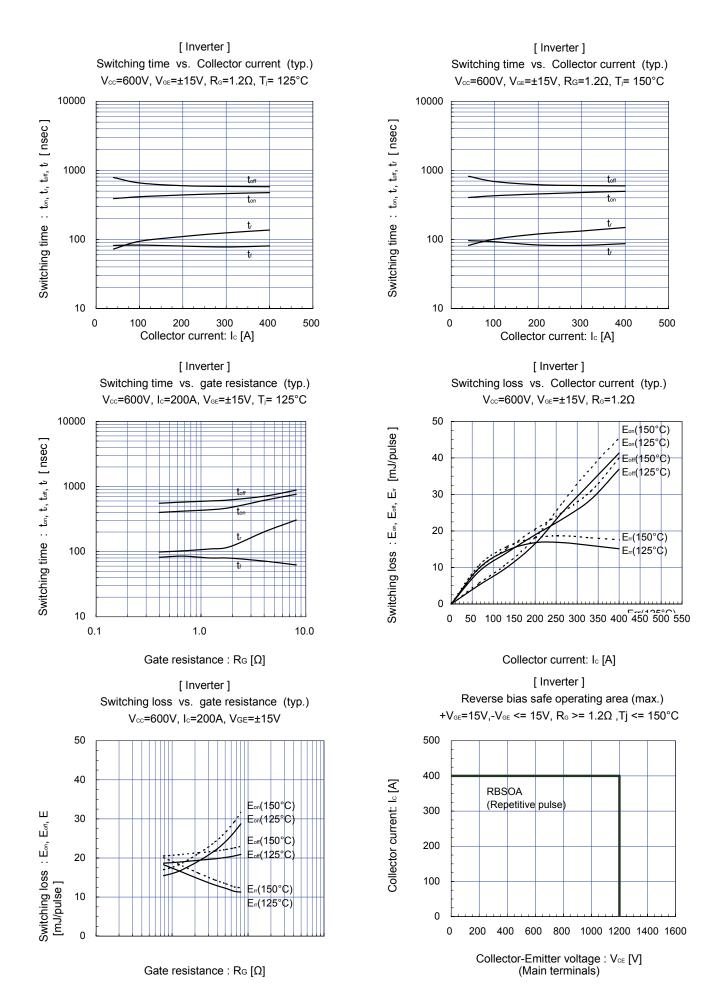


[Inverter]

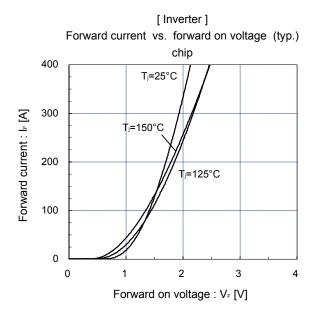
Dynamic gate charge (typ.)

Vcc=600V, Ic=200A,Tj= 25°C

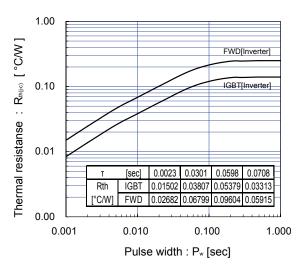


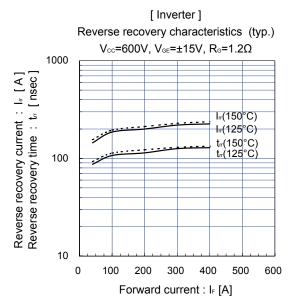


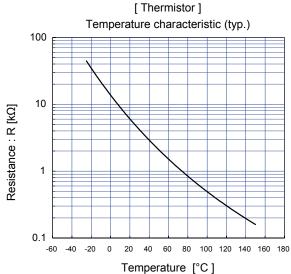
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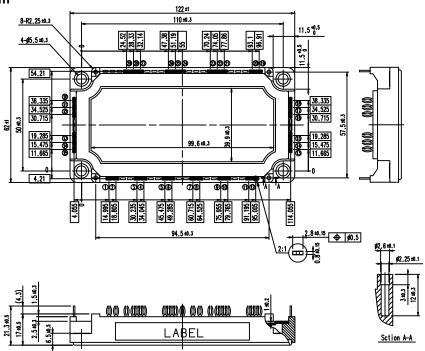
Transient thermal resistance (max.)







■ Outline Drawings, mm



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